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Software Document

MCU Driver Porting Guide

BHy1 - MCU Driver Porting Guide

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Notes

Data in this document are subject to change without notice. Product photos and pictures are for illustration purposes only and may differ from the real product's appearance.

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1. Prerequisites

Before the porting effort, the customer is expected to have a working sample code for i2c communication. In order to request and streamline support from a Bosch Sensortec FAE, a regional office, distributor or sales representative the customer is expected to provide proof of unsuccessful i2c transactions (i.e. a logic analyzer data-log).

2. Description of the package

The driver is separated in two parts: the API and the actual driver. Some files should not be modified; others should only be modified by power users and others need to be modified by all users.

2.1 API files

2.1.1 BHIfw.h

This file contains the definition of the RAM patch, also known as firmware file or fw file. The default RAM patch supports full 9DoF data fusion using the BMM150 magnetometer attached to the smart-hub. The author recommends to generate and to convert the available RAM patches automatically with a free tool called “fw2header”.

Link: <https://github.com/BoschSensortec/BHy1-fw-convert-tool>

This file **has to be modified for every RAM patch**.

2.1.2 bhy.h

This file contains the declarations for the BHy API. Refer to these for missing features in the driver. This file **should not be modified**.

2.1.3 bhy.c

This file contains the definitions of the BHy API.

This file **should not be modified**.

2.1.4 Bhy_support.h

This file contains the declarations of the platform-specific functions that the driver needs.

This file **should not be modified**.

2.1.5 Bhy_support.c

This file contains the definitions of the platform-specific functions that the driver needs.

This file **has to be modified for every platform**.

2.2 Driver files

2.2.1 bhy_uc_driver_config.h

This file allows you to enable/disable the debug and the callback features.

This file **should be modified for every application**

2.2.2 bhy_uc_driver_constants.h

This file contains the sensor ID definitions.

This file **may be modified if creating a new virtual sensor ID.***

2.2.3 bhy_uc_driver_types.h

This file contains all the types definition that are used in the driver. The user should look through this file and use these types.

This file **may be modified if creating a new virtual sensor ID.***

2.2.4 bhy_uc_driver.h

This file contains the driver functions declarations that are called from the main application.

This file **should not be modified.**

2.2.5 bhy_uc_driver.c

This file contains the main code of the driver.

This file **may be modified if creating a new virtual sensor ID.***

***Note:**

Adding a new virtual sensor ID may impact your ability to merge new driver code into your modified version. It is only recommended for power users.

3. Porting instructions

3.1 Moving to a new platform

When moving to a new platform. The user needs to modify the “bhy_support.c” file and do the following:

- Remove the following lines that are Atmel-specific :

```
#include "twi.h"
```

```
/*! instantiates an I2C packet software instance structure which retains  
* I2C slave address, data buffer and data length and is used to read/write  
* data on the I2C bus */
```

```
twi_packet_t bhy_i2c_packet;
```

- Edit the generic bhy_i2c_write function so that it makes an i2c write to the specified address and register on your platform
- Edit the generic bhy_i2c_read function so that it makes an i2c read to the specified address and register on your platform
- In your main code, make sure you implement a function called “mdelay” that creates a delay of roughly 1ms

When compiling the code it will automatically try to detect the fixed-width types for your platform. If this fails, you will get the following compiler warning:

```
#warning the data types defined above which not supported define the data types manually
```

If that happens, then you need to modify the bhy.h file to define the following fixed-width types: s8, s16, s32, u8, u16, u32

4. Using the driver

4.1 Configuration

The driver has 2 configuration parameters. The user needs to set them in `bhy_uc_driver_config.h`

4.1.1 BHY_DEBUG

This setting allows the driver to print debug messages. The BHy firmware releases do not output debug messages, so this parameter should only be set to '1' by users in development of their own BHy firmware. Otherwise it should be set to '0'

4.1.2 BHY_CALLBACK_MODE

This setting allows the callback feature of the driver. A callback is a software interrupt. If enabled, the installed software callbacks will automatically be called when the FIFO packets are decoded in the parsing process. The callbacks are called in the context of the FIFO parsing function. The only drawback is that it uses a little bit of RAM (~350 bytes on a 32-bit system).

4.1.3 BHY_APPLICATION_BOARD

This setting allows the driver to work successfully on the BST application board limiting the I²C transaction sizes to 51 bytes.

4.1.4 RAM patch modifications

A compiled RAM patch comes in the *.fw format, which is a pure binary file. The user has to create a C constant definition with the binary data included in the firmware file. This data has to be put in `BHIfw.h`.

4.2 Usage

The driver helps you in 3 phases of the application code: initialization, configuration and data readout.

4.2.1 Initialization

To initialize the driver, the user should make sure that the MCU has configured i2c module and then call the `bhy_driver_init` function. This will initialize the driver, download the RAM patch to the `bhy` from the ROM of the MCU, verify the checksum, launch the Fuser core and report an error code. If the status return value is `BHY_SUCCESS`, then the initialization was successful.

4.2.3 Configuration

To configure the driver for you application, the user needs to enable the required sensors via the `bhy_enable_virtual_sensor` function. Then he may want to install either sensor callbacks, timestamp callbacks or meta_event callbacks with the functions `bhy_install_sensor_callback`, `bhy_install_timestamp_callback` and `bhy_install_meta_event_callback`.

***Note:**

Code that is released to consumers should always monitor the `BHY_META_EVENT_TYPE_ERROR` and `BHY_META_EVENT_TYPE_SENSOR_ERROR` meta events for increased robustness.

4.2.3 Data readout

The data readout is done in two phase: reading the FIFO data from the `bhy` into the MCU memory via the `bhy_read_fifo` function, and then decoding binary data into useful data structures via the function `bhy_parse_next_fifo_packet`. The user should get familiar with the decoding algorithm provided in the sample code before modifying it.

5. Legal disclaimer

5.1 Engineering samples

Engineering Samples are marked with an asterisk (*) or (e) or (E). Samples may vary from the valid technical specifications of the product series contained in this data sheet. They are therefore not intended or fit for resale to third parties or for use in end products. Their sole purpose is internal client testing. The testing of an engineering sample may in no way replace the testing of a product series. Bosch Sensortec assumes no liability for the use of engineering samples. The Purchaser shall indemnify Bosch Sensortec from all claims arising from the use of engineering samples.

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5.3 Application examples and hints

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6. Document history and modification

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Bosch Sensortec GmbH
Gerhard-Kindler-Strasse 9
72770 Reutlingen / Germany
Contact@bosch-sensortec.com
www.bosch-sensortec.com
Modifications reserved
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